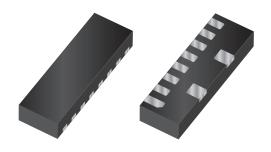


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Ultra Low Capacitance ESD TVS Array in DFN3310

Features

- 30Watts peak pulse power (tp = 8/20µs)
- Tiny DFN3310 package
- Protect up to 6-lines
- Solid-state silicon-avalanche technology
- Low clamping voltage
- Low leakage current
- Low capacitance (Cj=0.2pF typ. I/O to I/O)
- IEC 61000-4-2 ±8kV contact ±15kV air
- IEC 61000-4-4 (EFT) 40A (5/50ns)
- IEC 61000-4-5 (Lightning) 3A (8/20μs



DFN3310

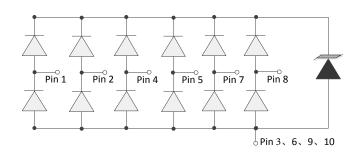
Applications

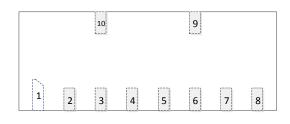
- USB 3.0/3.1,Type C
- HDMI 1.4/2.0, Display Port 1.3
- Unified Display interface
- Digital visual interface

Mechanical Data

- DFN3310 package
- Molding compound flammability rating: UL 94V-0
- Packaging: Tape and Reel
- RoHS/WEEE Compliant

Schematic & PIN Configuration







CESD3310UC5VU-M

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Absolute Maximum Rating

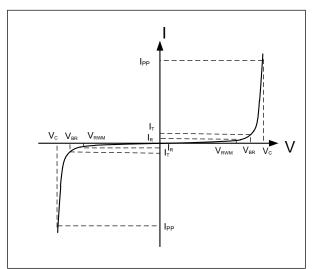
Rating	g Symbol Value		Units
Peak Pulse Power (t _p =8/20µs)	P _{PP}	30	Watts
Peak Pulse Current (t _p =8/20μs) (note1)	I _{pp}	3	А
ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	V _{ESD}	15 8	kV
Lead Soldering Temperature	TL	260(10seconds)	$^{\circ}$
Junction Temperature	TJ	-55 to + 125	$^{\circ}$ C
Storage Temperature	T _{stg}	-55 to + 125	$^{\circ}\!$

Electrical Characteristics

Parameter	Symbol	Conditions	Min	Typical	Max	Units
Reverse Stand-Off Voltage	V_{RWM}				5.0	V
Reverse Breakdown Voltage	akdown Voltage V _{BR} I _T =1mA 6.0		7.2	9.5	V	
Reverse Leakage Current	ırrent I _R V _{RWM} =5V,T=25℃ 0.1		0.1	0.5	μΑ	
Peak Pulse Current	I _{PP}	tp =8/20µs			3	Α
Clamping Voltage	V _C	I _{PP} =3A,t _p =8/20μs			10	V
Junction Capacitance	C _j	V _R = 0V, f = 1MHz I/O to I/O		0.2		pF
		$V_R = 0V, f = 1MHz I/O to GND$		0.4		pF

Electrical Parameters (TA = 25°C unless otherwise noted)

Symbol	Parameter
I PP	Maximum Reverse Peak Pulse Current
Vc	Clamping Voltage @ IPP
VRWM	Working Peak Reverse Voltage
IR	Maximum Reverse Leakage Current @ VRWM
V _{BR}	Breakdown Voltage @ I⊤
lτ	Test Current



Note: 8/20µs pulse waveform.



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Typical Characteristics

Fig.1 IEC61000-4-2 Waveform

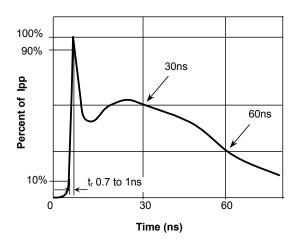


Fig.3 Eye Diagram - USB3.1 at 10Gbps per channel

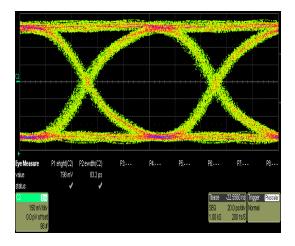


Fig.2 IEC61000-4-2 +8kV Contact ESD Clamping Waveform

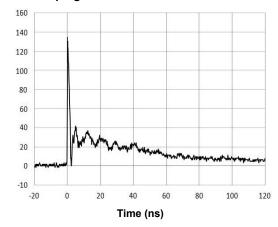
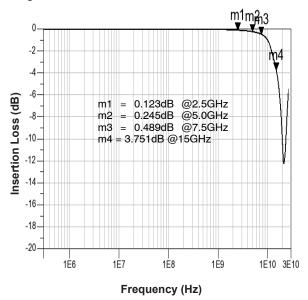


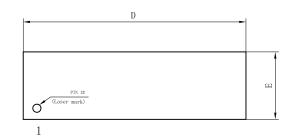
Fig.4 Insertion Loss S21 - I/O to I/O

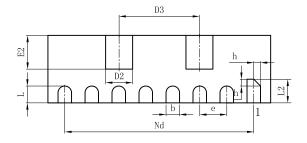


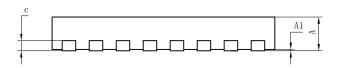


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Outline Drawing - DFN3310







SYMBOL	MILLIMETER			
STMBOL	MIN	NOM	MAX	
A	0.45	0.50	0. 55	
A1	_	0.02	0.05	
ь	0. 15	0. 20	0. 25	
с	0.100	0. 152	0. 200	
D	3. 25	3. 30	3. 35	
D2	0.30	0.35	0.40	
D3	1. 19BSC			
e	0. 40BSC			
Nd	2.80BSC			
Е	0. 95	1.00	1.05	
E2	0. 45	0.50	0. 55	
L	0. 20	0.25	0.30	
L2	0.30	0.35	0.40	
h	0.05	0.10	0.15	

Marking

L5U

Ordering information

Order code	Package	Base qty	Delivery mode
CESD3310UC5VU-M	DFN3310	3000	Tape and reel



CESD3310UC5VU-M

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